

1. General description

Hyperfast power diode in 2-lead TO220F plastic package.



2. Features and benefits

- Fast switching
- Isolated plastic package
- Low leakage current
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET or IGBT
- Package meets UL94V0 which guaranteed by epoxy mold compound

3. Applications

- Active PFC in air conditioner
- High frequency switched-mode power supplies
- Power Factor Correction (PFC)

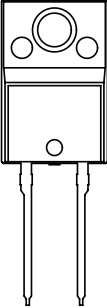

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Notes | Values | | | Unit |
|-------------------------|-------------------------------------|--|-------|--------|------|------|------|
| Absolute maximum rating | | | | | | | |
| V _{RRM} | repetitive peak reverse voltage | | | 650 | | | V |
| I _{F(AV)} | average forward current | δ = 0.5 ; square-wave pulse; Fig. 1 ; Fig. 2 | | 15 | | | A |
| I _{FRM} | repetitive peak forward current | δ = 0.5 ; t _p = 25 μs; square-wave pulse | | 30 | | | A |
| I _{FSM} | non-repetitive peak forward current | t _p = 10 ms; T _{j(init)} = 25 °C; sine-wave pulse; Fig. 3 | | 180 | | | A |
| | | t _p = 8.3 ms; T _{j(init)} = 25 °C; sine-wave pulse | | 198 | | | A |
| Symbol | Parameter | Conditions | Notes | Min | Typ | Max | Unit |
| Static characteristics | | | | | | | |
| V _F | forward voltage | I _F = 15 A; T _j = 25 °C; Fig. 5 | | - | 1.75 | 2.40 | V |
| | | I _F = 15 A; T _j = 150 °C; Fig. 5 | | - | 1.35 | 2.00 | V |
| Dynamic characteristics | | | | | | | |
| t _{rr} | reverse recovery time | I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; Fig. 6 | | - | 26 | - | ns |

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline | Graphic symbol |
|-----|--------|-------------------------|---|---|
| 1 | K | cathode |  |  |
| 2 | A | anode | | |
| mb | n.c. | mounting base; isolated | | |

6. Ordering information

Table 3. Ordering information

| Type number | Package Name | Orderable part number | Packing method | Small packing quantity | Package version | Package issue date |
|--------------|--------------|-----------------------|----------------|------------------------|-----------------|--------------------|
| BYV15MX-650P | TO220F-2L | BYV15MX-650PQ | Tube | 50 | TO220Fd-2L | 02-Aug-2022 |

7. Marking

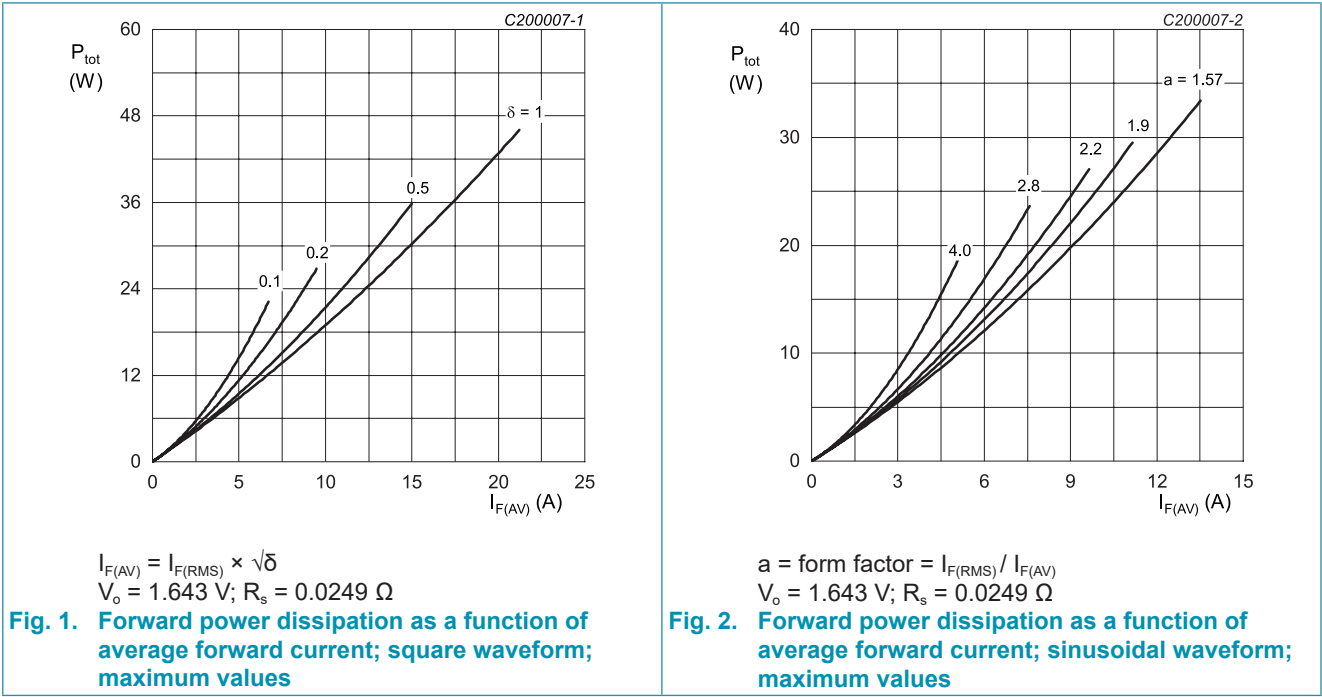
Table 4. Marking codes

| Type number | Marking codes |
|--------------|-----------------|
| BYV15MX-650P | BYV15MX 650P |

8. Limiting values

Table 5. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Notes | Values | Unit |
|-------------|-------------------------------------|--|-------|------------|------------|
| V_{RRM} | repetitive peak reverse voltage | | | 650 | V |
| V_{RWM} | crest working reverse voltage | | | 650 | V |
| V_R | reverse voltage | DC | | 650 | V |
| $I_{F(AV)}$ | average forward current | $\delta = 0.5$; square-wave pulse; Fig. 1 ; Fig. 2 | | 15 | A |
| I_{FRM} | repetitive peak forward current | $\delta = 0.5$; $t_p = 25 \mu s$; square-wave pulse | | 30 | A |
| I_{FSM} | non-repetitive peak forward current | $t_p = 10 ms$; $T_{j(init)} = 25 \text{ }^\circ C$; sine-wave pulse; Fig. 3 | | 180 | A |
| | | $t_p = 8.3 ms$; $T_{j(init)} = 25 \text{ }^\circ C$; sine-wave pulse | | 198 | A |
| T_{stg} | storage temperature | | | -65 to 175 | $^\circ C$ |
| T_j | junction temperature | | | -65 to 175 | $^\circ C$ |



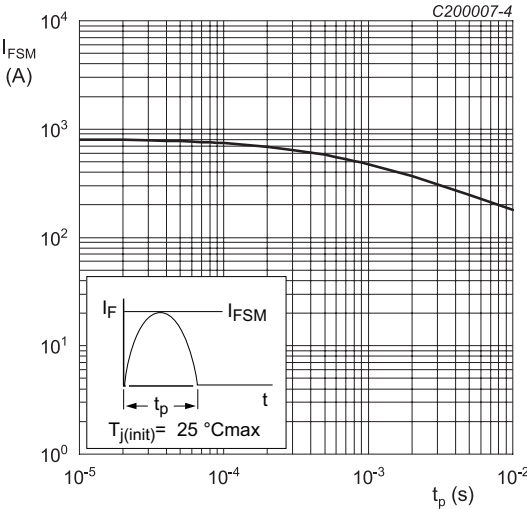
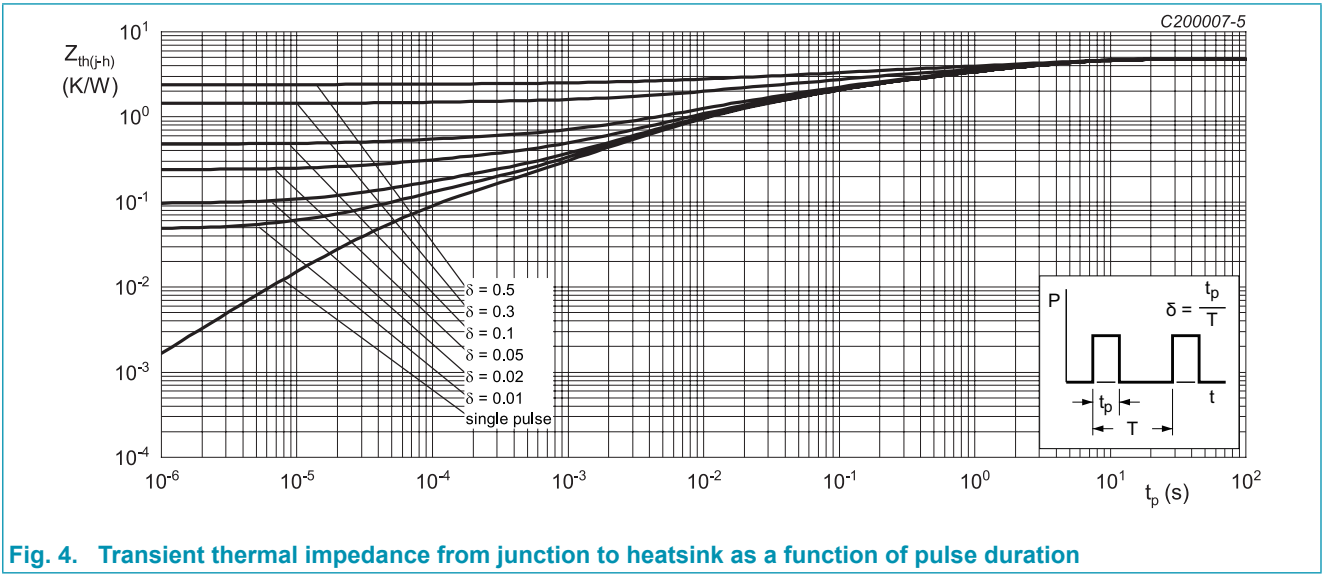


Fig. 3. Non-repetitive peak forward current as a function of pulse width; sinusoidal waveform; maximum values

9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Notes | Min | Typ | Max | Unit |
|---------------|--|--|-------|-----|-----|-----|------|
| $R_{th(j-h)}$ | thermal resistance from junction to heatsink | with heatsink compound; Fig. 4 | | - | - | 4.8 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient free air | in free air | | - | 60 | - | K/W |



10. Isolation characteristics

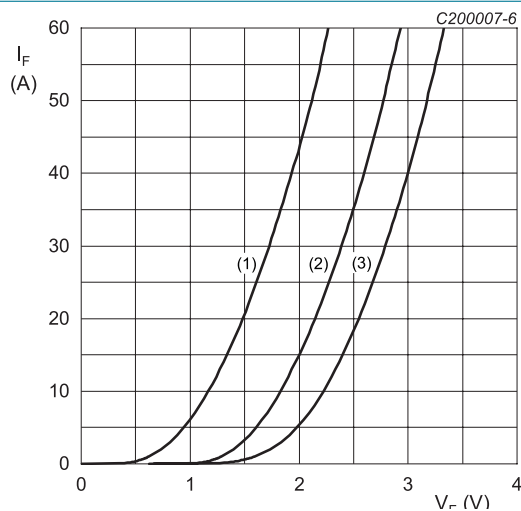
Table 7. Isolation characteristics

| Symbol | Parameter | Conditions | Notes | Min | Typ | Max | Unit |
|-----------------|-----------------------|---|-------|-----|-----|------|------|
| $V_{isol(RMS)}$ | RMS isolation voltage | $50\text{ Hz} \leq f \leq 60\text{ Hz}$; $RH \leq 65\%$; from all pins to external heatsink; sinusoidal waveform; clean and dust free | | - | - | 2500 | V |
| C_{isol} | isolation capacitance | $f = 1\text{ MHz}$; from cathode to external heatsink | | - | 10 | - | pF |

11. Characteristics

Table 8. Characteristics

| Symbol | Parameter | Conditions | Notes | Min | Typ | Max | Unit |
|-------------------------|---------------------------------|--|-------|------|------|------|------|
| Static characteristics | | | | | | | |
| V _F | forward voltage | I _F = 15 A; T _j = 25 °C; Fig. 5 | | - | 1.75 | 2.40 | V |
| | | I _F = 15 A; T _j = 150 °C; Fig. 5 | | - | 1.45 | 2.10 | V |
| I _R | reverse current | V _R = 650 V; T _j = 25 °C | | - | 0.5 | 30 | μA |
| | | V _R = 650 V; T _j = 150 °C | | - | - | 0.8 | mA |
| Dynamic characteristics | | | | | | | |
| Q _r | reverse charge | I _F = 15 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 25 °C; Fig. 6 | | - | 80 | - | nC |
| | | I _F = 15 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 125 °C; Fig. 6 | | - | 330 | - | nC |
| t _{rr} | reverse recovery time | I _F = 0.5 A; I _{rr} = 0.25 A; I _R = 1 A; T _j = 25 °C; Fig. 6 | | - | 28 | - | ns |
| | | I _F = 1 A; V _R = 30 V; dI _F /dt = 100 A/μs; T _j = 25 °C; Fig. 6 | | - | 26 | - | ns |
| | | I _F = 15 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 25 °C; Fig. 6 | | - | 45 | - | ns |
| | | I _F = 15 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 125 °C; Fig. 6 | | - | 85 | - | ns |
| I _{RM} | peak reverse recovery current | I _F = 15 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 25 °C; Fig. 6 | | - | 3.5 | - | A |
| | | I _F = 15 A; V _R = 200 V; dI _F /dt = 200 A/μs; T _j = 125 °C; Fig. 6 | | - | 7.2 | - | A |
| E _{as} | non-repetitive avalanche energy | T _{j(init)} = 25 °C | | 16.8 | - | - | mJ |



$V_o = 1.643\text{ V}$; $R_s = 0.0249\text{ }\Omega$

(1) $T_J = 150\text{ °C}$; typical values

(2) $T_J = 150\text{ °C}$; maximum values

(3) $T_J = 25\text{ °C}$; maximum values

Fig. 5. Forward current as a function of forward voltage

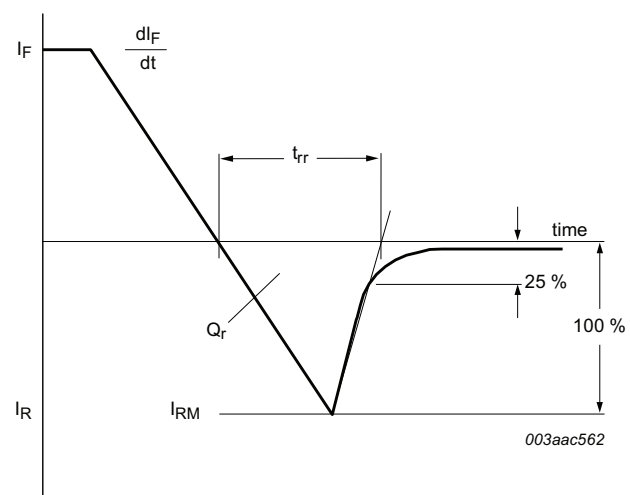
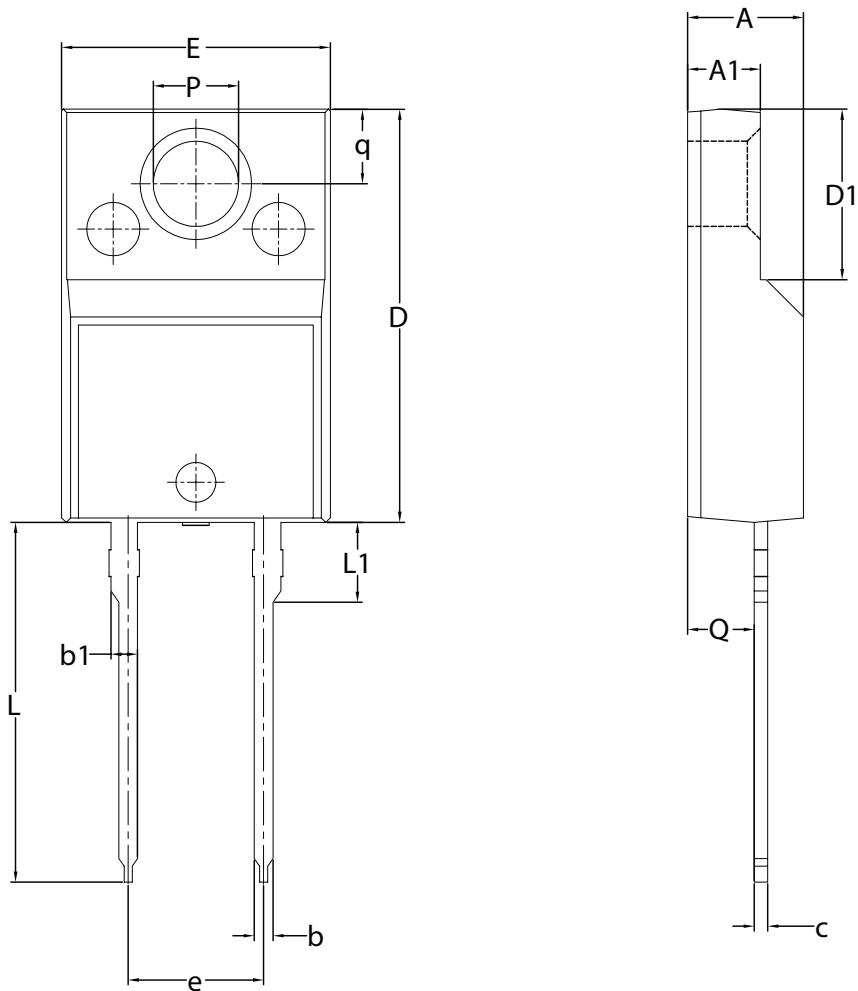


Fig. 6. Reverse recovery definitions; ramp recovery

12. Package outline

Plastic single-ended package; isolated heatsink mounted;1 mounting hole; 2 leads TO-220 'full pack' TO220F-2L



| Unit | A | A1 | b | b1 | c | D | D1 | E | e | L | L1 | P | Q | q |
|------|------|------|------|------|------|-------|------|-------|-------|-------|------|------|------|------|
| min | 4.00 | 2.50 | 0.70 | 0.90 | 0.40 | 15.20 | 6.30 | 9.80 | 5.08 | 13.50 | 2.80 | 3.00 | 2.30 | 2.60 |
| max | 4.60 | 3.10 | 0.90 | 1.10 | 0.70 | 15.80 | 6.50 | 10.30 | (BSC) | 14.40 | 3.30 | 3.40 | 2.80 | 3.00 |

Note:
1. All dimensions don't include mold flash and metal protrusion.

13. Legal information

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|--------------------------------|--------------------|---|
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